

February 1994 Revised August 2002

74LCX16646

Low Voltage 16-Bit Transceiver/Register with 5V Tolerant Inputs and Outputs

General Description

The LCX16646 contains sixteen non-inverting bidirectional registered bus transceivers with 3-STATE outputs, providing multiplexed transmission of data directly from the input bus or from the internal storage registers. Each byte has separate control inputs which can be shorted together for full 16-bit operation. The DIR inputs determine the direction of data flow through the device. The CPAB and CPBA inputs load data into the registers on the LOW-to-HIGH transition (see Functional Description).

The LCX16646 is designed for low voltage (2.5V or 3.3V) V_{CC} applications with capability of interfacing to a 5V signal environment

The LCX16646 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

Features

- 5V tolerant inputs and outputs
- 2.3V-3.6V V_{CC} specifications provided
- \blacksquare 5.2 ns t_{PD} max (V $_{CC}$ = 3.3V), 20 μA I_{CC} max
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- \pm 24 mA Output Drive (V_{CC} = 3.0V)
- Implements patented noise/EMI reduction circuitry
- Latch-up performance exceeds 500 mA
- ESD performance: Human Body Model > 2000V Machine Model > 200V

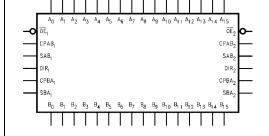
Note 1: To ensure the high-impedance state during power up or down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pull-up resistor: the minimum value or the resistor is determined by the current-sourcing capability of the driver.

Ordering Code:

Order Number Package Number			Package Description
74	4LCX16646MEA	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74	4LCX16646MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol



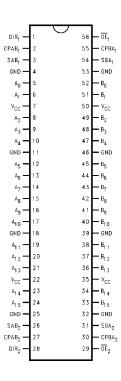
Pin Descriptions

Pin Names	Description
A _n	Side A Inputs or 3-STATE Outputs
B _n	Side B Inputs or 3-STATE Outputs
OE _n	Output Enable Inputs
CPAB _n , CPBA _n	Clock Pulse Inputs
SAB _n , SBA _n	Select Inputs
DIR _n	Direction Control Inputs

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Connection Diagram



Truth Table

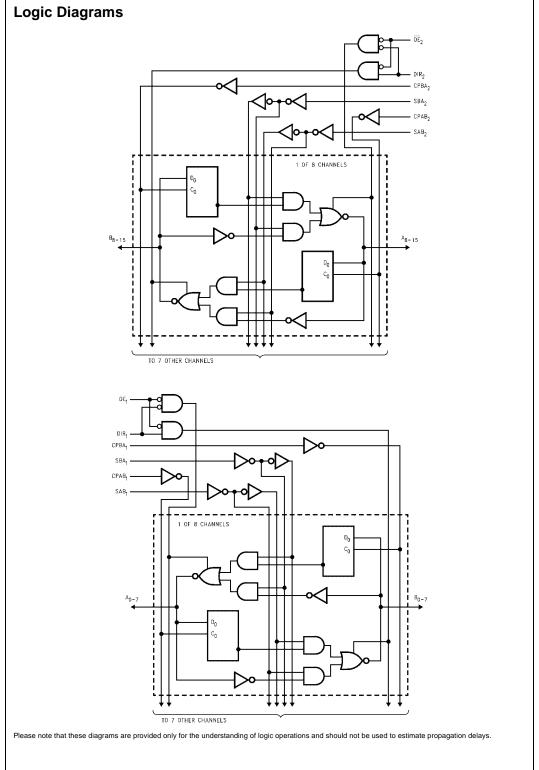
(Note 2)

Inputs					Data I/O		Output Operation Made	
OE ₁	DIR ₁	CPAB ₁	CPBA ₁	SAB ₁	SBA ₁	A ₀₋₇	B ₀₋₇	Output Operation Mode
Н	Х	H or L	H or L	Х	Х			Isolation
Н	X	~	X	X	Χ	Input	Input	Clock A _n Data into A Register
Н	X	X	~	X	X			Clock B _n Data Into B Register
L	Н	Х	Х	L	Х			A _n to B _n — Real Time (Transparent Mode)
L	Н	~	X	L	Χ	Input	Output	Clock A _n Data to A Register
L	Н	H or L	X	Н	X			A Register to B _n (Stored Mode)
L	Н	~	X	Н	X			Clock \mathbf{A}_n Data into A Register and Output to \mathbf{B}_n
L	L	Х	Х	Χ	L			B _n to A _n — Real Time (Transparent Mode)
L	L	Χ	~	X	L	Output	Input	Clock B _n Data into B Register
L	L	Χ	H or L	X	Н			B Register to A _n (Stored Mode)
L	L	Х	~	Χ	Н			Clock $\mathbf{B}_{\mathbf{n}}$ into \mathbf{B} Register and Output to $\mathbf{A}_{\mathbf{n}}$

H = HIGH Voltage Level X = Immaterial

Note 2: The data output functions may be enabled or disabled by various signals at the \overline{OE} and DIR inputs. Data input functions are always enabled; i.e., data at the bus pins will be stored on every LOW-to-HIGH transition of the appropriate clock inputs. Also applies to data I/O (A and B: 8-15) and #2 control pins.

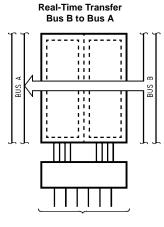
 $[\]mathsf{L} = \mathsf{LOW} \; \mathsf{Voltage} \; \mathsf{Level} \qquad \mathscr{_} = \mathsf{LOW}\text{-to-HIGH} \; \mathsf{Transition}.$



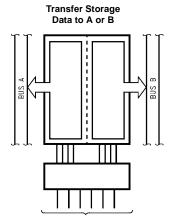
Functional Description

In the transceiver mode, data present at the HIGH impedance port may be stored in either the A or B register or both. The select $(\mathsf{SAB}_n,\ \mathsf{SBA}_n)$ controls can multiplex stored and real-time. The examples shown below demonstrate the four fundamental bus-management functions that can be performed.

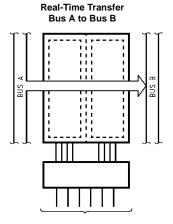
The direction control (DIRn) determines which bus will receive data when \overline{OE}_n is LOW. In the isolation mode $(\overline{OE}_n$ HIGH), A data may be stored in one register and/or B data may be stored in the other register. When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two busses, A or B, may be driven at a time.



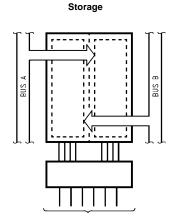
OE DIR CPAB CPBA SAB SBA



OE DIR CPAB CPBA SAB SBA
L L X HorL X H
L H HorL X H X



OE DIR CPAB CPBA SAB SBA



OE DIR CPAB CPBA SAB SBA L Χ L Χ Χ Χ L Н Χ Χ Х Н Χ Χ Χ

Absolute Maximum Ratings(Note 3)						
Symbol	Parameter	Value	Conditions	Units		
V _{CC}	Supply Voltage	-0.5 to +7.0		V		
V _I	DC Input Voltage	−0.5 to +7.0		V		
Vo	DC Output Voltage	−0.5 to +7.0	Output in 3-STATE	V		
		-0.5 to $V_{CC} + 0.5$	Output in HIGH or LOW State (Note 4)	v		
I _{IK}	DC Input Diode Current	-50	V _I < GND	mA		
l _{ok}	DC Output Diode Current	-50	V _O < GND	mA		
		+50	$V_O > V_{CC}$	IIIA		
Io	DC Output Source/Sink Current	±50		mA		
I _{CC}	DC Supply Current per Supply Pin	±100		mA		
I _{GND}	DC Ground Current per Ground Pin	±100		mA		
T _{STG}	Storage Temperature	-65 to +150		°C		

Recommended Operating Conditions (Note 5)

Symbol	Parameter			Max	Units
V _{CC}	Supply Voltage	Operating	2.0	3.6	V
		Data Retention	1.5	3.6	V
VI	Input Voltage		0	5.5	V
Vo	Output Voltage	HIGH or LOW State	0	V _{CC}	V
		3-STATE	0	5.5	V
I _{OH} /I _{OL}	Output Current	$V_{CC} = 3.0V - 3.6V$		±24	
		$V_{CC} = 2.7V - 3.0V$ $V_{CC} = 2.3V - 2.7V$		±12	mA
		$V_{CC} = 2.3V - 2.7V$		±8	
T _A	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, $V_{IN} = 0.8V-2.0V$, $V_{CC} = 3.0V$		0	10	ns/V

Note 3: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 4: I_O Absolute Maximum Rating must be observed.

Note 5: Unused inputs and I/Os must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	Conditions	v _{cc}	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units
		Conditions	(V)	Min	Max	Units
V _{IH}	HIGH Level Input Voltage		2.3 – 2.7	1.7		V
			2.7 – 3.6	2.0		v
V _{IL}	LOW Level Input Voltage		2.3 – 2.7		0.7	V
			2.7 – 3.6		0.8	V
V _{OH}	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	2.3 – 3.6	V _{CC} - 0.2		
		$I_{OH} = -8 \text{ mA}$	2.3	1.8		
		$I_{OH} = -12 \text{ mA}$	2.7	2.2		V
		$I_{OH} = -18 \text{ mA}$	3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2.2		
√ _{OL}	LOW Level Output Voltage	I _{OL} = 100 μA	2.3 – 3.6		0.2	
		$I_{OL} = 8 \text{ mA}$	2.3		0.6	
		$I_{OL} = 12 \text{ mA}$	2.7		0.4	V
		$I_{OL} = 16 \text{ mA}$	3.0		0.4	
		I _{OL} = 24 mA	3.0		0.55	
ı	Input Leakage Current	$0 \le V_I \le 5.5V$	2.3 – 3.6		±5.0	μΑ
OZ	3-STATE I/O Leakage	$0 \le V_O \le 5.5V$	2.3 – 3.6		±5.0	μА
		$V_I = V_{IH}$ or V_{IL}	2.3 - 3.0		±3.0	μА
OFF	Power-Off Leakage Current	V_I or $V_O = 5.5V$	0		10	μΑ

DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V_{CC} $T_A = -40^{\circ}C$		C to +85°C	Units
· ,	. aramoto	- Communication	(V)	Min	Max	•
I _{CC}	Quiescent Supply Current	$V_I = V_{CC}$ or GND	2.3 – 3.6		20	μА
		3.6V ≤ V _I , V _O ≤ 5.5V (Note 6)	2.3 – 3.6		±20	μΛ
ΔI_{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6V$	2.3 – 3.6		500	μА

Note 6: Outputs disabled or 3-STATE only.

AC Electrical Characteristics

			$T_A = -40^{\circ}C$ to $+85^{\circ}C$, $R_L = 500\Omega$					
Symbol	Parameter	V _{CC} = 3.	3V ± 0.3V	V _{CC}	= 2.7V	V _{CC} = 2.	5V ± 0.2V	Unita
Symbol	Parameter	C _L = 50 pF		C _L = 50 pF		C _L = 30 pF		Units
		Min	Max	Min	Max	Min	Max	
f _{MAX}	Maximum Clock Frequency	170						ns
t _{PHL}	Propagation Delay	1.5	5.2	1.5	6.0	1.5	6.2	200
t _{PLH}	Bus to Bus	1.5	5.2	1.5	6.0	1.5	6.2	ns
t _{PHL}	Propagation Delay	1.5	6.0	1.5	7.0	1.5	7.2	
t _{PLH}	Clock to Bus	1.5	6.0	1.5	7.0	1.5	7.2	ns
t _{PHL}	Propagation Delay	1.5	6.0	1.5	7.0	1.5	7.2	
t _{PLH}	Select to Bus	1.5	6.0	1.5	7.0	1.5	7.2	ns
t _{PZL}	Output Enable Time	1.5	7.5	1.5	8.5	1.5	9.8	
t_{PZH}		1.5	7.5	1.5	8.5	1.5	9.8	ns
t _{PLZ}	Output Disable Time	1.5	6.5	1.5	7.5	1.5	7.8	
t_{PHZ}		1.5	6.5	1.5	7.5	1.5	7.8	ns
t _S	Setup Time	2.5		2.5		3.0		ns
t _H	Hold Time	1.5		1.5		2.0		ns
t _W	Pulse Width	3.0		3.0		3.5		ns
toshl	Output to Output Skew (Note 7)		1.0					200
toslh			1.0					ns

Note 7: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}). Parameter guaranteed by design.

Dynamic Switching Characteristics

Symbol	Parameter	Conditions	V _{CC}	$T_A = 25^{\circ}C$	Units
- Cyllibol		Conditions	(V)	Typical	Omia
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	0.8	W
		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	2.5	0.6	V
V _{OLV}		$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	-0.8	V
		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	2.5	-0.6	V

Capacitance

Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	7	pF
C _{I/O}	Input/Output Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC} , $F = 10$ MHz	20	pF

AC LOADING and WAVEFORMS Generic for LCX Family

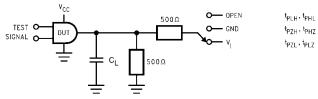
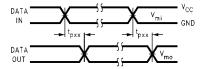
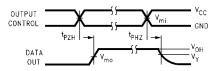


FIGURE 1. AC Test Circuit (C_L includes probe and jig capacitance)

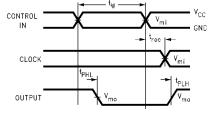
Test	Switch
t _{PLH} , t _{PHL}	Open
t _{PZL} , t _{PLZ}	6V at V_{CC} = 3.3 \pm 0.3V V_{CC} x 2 at V_{CC} = 2.5 \pm 0.2V
t_{PZH}, t_{PHZ}	GND



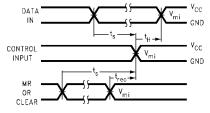
Waveform for Inverting and Non-Inverting Functions



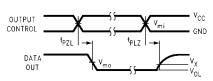
3-STATE Output High Enable and Disable Times for Logic



Propagation Delay. Pulse Width and t_{rec} Waveforms



Setup Time, Hold Time and Recovery Time for Logic



3-STATE Output Low Enable and Disable Times for Logic

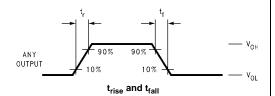
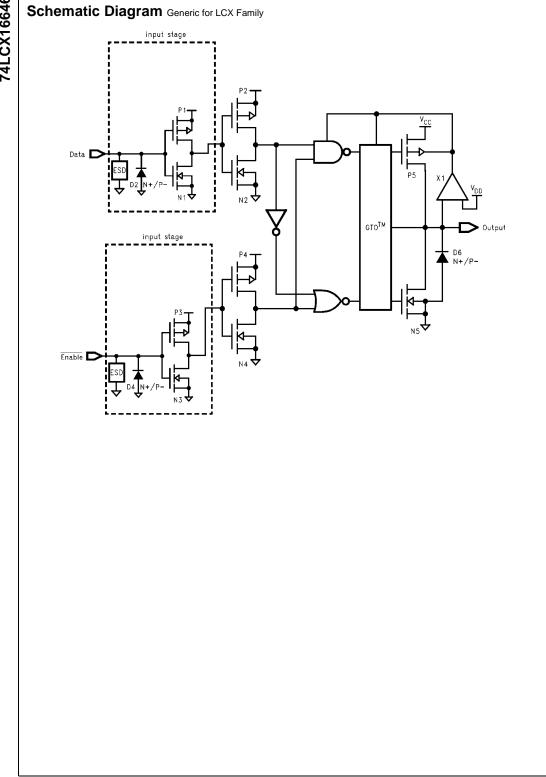
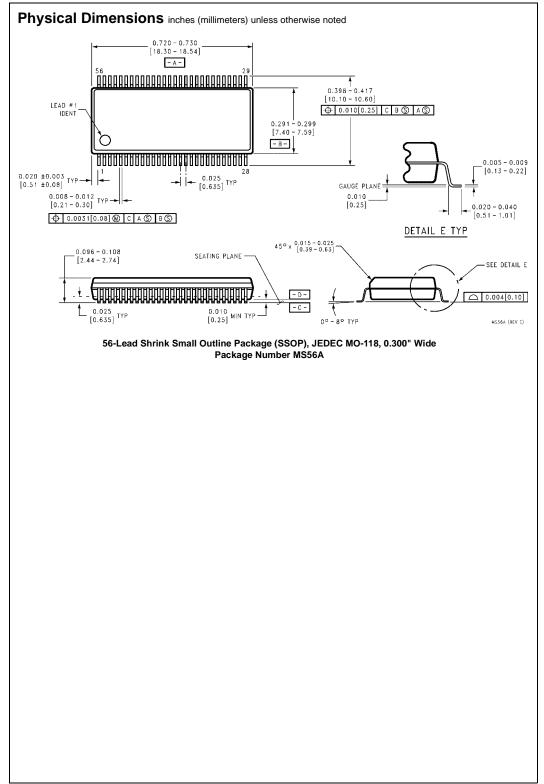
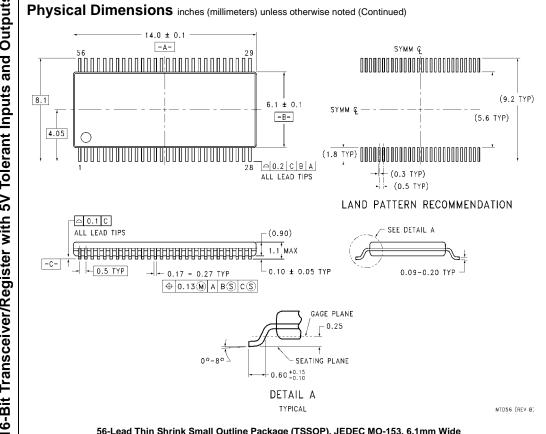


FIGURE 2. Waveforms (Input Characteristics; f =1MHz, $t_R = t_F = 3ns$)

Symbol	V _{CC}					
Cymbe.	$3.3V \pm 0.3V$	2.7V	2.5V ± 0.2V			
V _{mi}	1.5V	1.5V	V _{CC} /2			
V_{mo}	1.5V	1.5V	V _{CC} /2			
V _x	V _{OL} + 0.3V	V _{OL} + 0.3V	V _{OL} + 0.15V			
V _y	V _{OH} – 0.3V	V _{OH} – 0.3V	V _{OH} – 0.15V			







56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD56

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